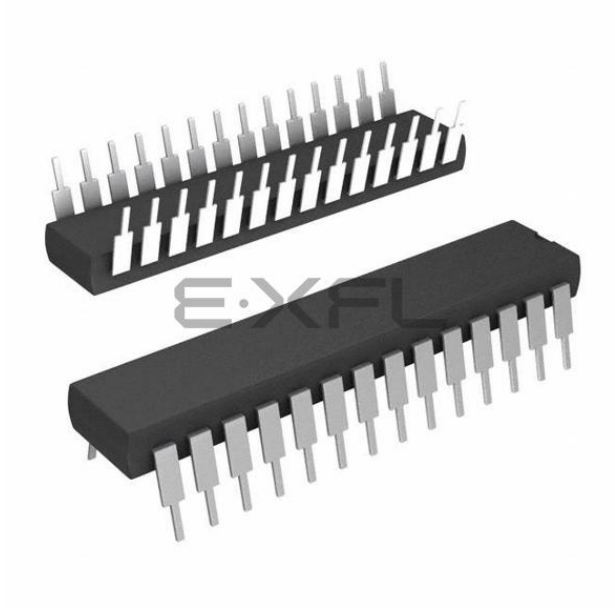

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Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	48MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	22
Program Memory Size	64KB (32K x 16)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	3.8K x 8
Voltage - Supply (Vcc/Vdd)	2.15V ~ 3.6V
Data Converters	A/D 10x10b/12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-SPDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic18f26j13-i-sp

TABLE 1-3: PIC18F2XJ13 PINOUT I/O DESCRIPTIONS (CONTINUED)

Pin Name	Pin Number		Pin Type	Buffer Type	Description
	28-SPDIP/ SSOP/ SOIC	28-QFN			
VSS1	8	5	P	—	Ground reference for logic and I/O pins.
VSS2	19	16	—	—	
VDD	20	17	P	—	Positive supply for peripheral digital logic and I/O pins.
VDDCORE/VCAP	6	3	—	—	Core logic power or external filter capacitor connection.
VDDCORE			P	—	Positive supply for microcontroller core logic (regulator disabled).
VCAP			P	—	External filter capacitor connection (regulator enabled).

Legend: TTL = TTL compatible input; CMOS = CMOS compatible input or output; ST = Schmitt Trigger input with CMOS levels; Analog = Analog input; I = Input; O = Output; P = Power; OD = Open-Drain (no P diode to VDD); DIG = Digital output; I^2C = Open-Drain, I^2C specific

Note 1: RA7 and RA6 will be disabled if OSC1 and OSC2 are used for the clock function.

2: 5.5V tolerant.

TABLE 5-2: INITIALIZATION CONDITIONS FOR ALL REGISTERS (CONTINUED)

Register	Applicable Devices		Power-on Reset, Brown-out Reset, Wake From Deep Sleep	$\overline{\text{MCLR}}$ Resets WDT Reset RESET Instruction Stack Resets CM Resets	Wake-up via WDT or Interrupt
IPR1	PIC18F2XJ13	PIC18F4XJ13	1111 1111	1111 1111	uuuu uuuu
PIR1	PIC18F2XJ13	PIC18F4XJ13	0000 0000	0000 0000	uuuu uuuu(3)
PIE1	PIC18F2XJ13	PIC18F4XJ13	0000 0000	0000 0000	uuuu uuuu
RCSTA2	PIC18F2XJ13	PIC18F4XJ13	0000 0000	0000 0000	uuuu uuuu
OSCTUNE	PIC18F2XJ13	PIC18F4XJ13	0000 0000	0000 0000	uuuu uuuu
T1GCON	PIC18F2XJ13	PIC18F4XJ13	0000 0x00	0000 0x00	uuuu uxuu
T3GCON	PIC18F2XJ13	PIC18F4XJ13	0000 0x00	uuuu uxuu	uuuu uxuu
TRISE(5)	—	PIC18F4XJ13	00-- -111	00-- -111	uu-- -uuu
TRISD(5)	—	PIC18F4XJ13	1111 1111	1111 1111	uuuu uuuu
TRISC	PIC18F2XJ13	PIC18F4XJ13	1111 1111	1111 1111	uuuu uuuu
TRISB	PIC18F2XJ13	PIC18F4XJ13	1111 1111	1111 1111	uuuu uuuu
TRISA	PIC18F2XJ13	PIC18F4XJ13	111- 1111	111- 1111	uuu- uuuu
PIE5	PIC18F2XJ13	PIC18F4XJ13	--00 0000	--00 0000	--uu uuuu
IPR4	PIC18F2XJ13	PIC18F4XJ13	1111 1111	1111 1111	uuuu uuuu
PIR4	PIC18F2XJ13	PIC18F4XJ13	0000 0000	0000 0000	uuuu uuuu
PIE4	PIC18F2XJ13	PIC18F4XJ13	0000 0000	0000 0000	uuuu uuuu
LATE(5)	—	PIC18F4XJ13	---- -xxx	---- -uuu	---- -uuu
LATD(5)	—	PIC18F4XJ13	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATC	PIC18F2XJ13	PIC18F4XJ13	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATB	PIC18F2XJ13	PIC18F4XJ13	xxxx xxxx	uuuu uuuu	uuuu uuuu
LATA	PIC18F2XJ13	PIC18F4XJ13	xxx- xxxx	uuu- uuuu	uuu- uuuu
DMACON1	PIC18F2XJ13	PIC18F4XJ13	0000 0000	0000 0000	uuuu uuuu
OSCCON2	PIC18F2XJ13	PIC18F4XJ13	-0-1 01--	-0-1 u1--	-u-u uu--
DMACON2	PIC18F2XJ13	PIC18F4XJ13	0000 0000	0000 0000	uuuu uuuu
HLVDCON	PIC18F2XJ13	PIC18F4XJ13	0000 0000	0000 0000	uuuu uuuu
PORTE(5)	—	PIC18F4XJ13	---- -xxx	---- -uuu	---- -uuu
PORTD(5)	—	PIC18F4XJ13	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTC	PIC18F2XJ13	PIC18F4XJ13	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTB	PIC18F2XJ13	PIC18F4XJ13	xxxx xxxx	uuuu uuuu	uuuu uuuu
PORTA	PIC18F2XJ13	PIC18F4XJ13	xxx- xxxx	uuu- uuuu	uuu- uuuu
SPBRGH1	PIC18F2XJ13	PIC18F4XJ13	0000 0000	0000 0000	uuuu uuuu
BAUDCON1	PIC18F2XJ13	PIC18F4XJ13	0100 0-00	0100 0-00	uuuu u-uu

Legend: u = unchanged, x = unknown, - = unimplemented bit, read as '0', q = value depends on condition.

Note 1: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the TOSU, TOSH and TOSL are updated with the current value of the PC. The STKPTR is modified to point to the next location in the hardware stack.

2: When the wake-up is due to an interrupt and the GIEL or GIEH bit is set, the PC is loaded with the interrupt vector (0008h or 0018h).

3: One or more bits in the INTCONx or PIRx registers will be affected (to cause wake-up).

4: See Table 5-1 for the Reset value for a specific condition.

5: Not implemented on PIC18F2XJ13 devices.

6: Not implemented on "LF" devices.

6.3 Data Memory Organization

Note: The operation of some aspects of data memory are changed when the PIC18 extended instruction set is enabled. See **Section 6.6 "Data Memory and the Extended Instruction Set"** for more information.

The data memory in PIC18 devices is implemented as static RAM. Each register in the data memory has a 12-bit address, allowing up to 4096 bytes of data memory. The memory space is divided into as many as 16 banks that contain 256 bytes each. The PIC18F47J13 Family implements all available banks and provides 3.8 Kbytes of data memory available to the user. Figure 6-6 provides the data memory organization for the devices.

The data memory contains Special Function Registers (SFRs) and General Purpose Registers (GPRs). The SFRs are used for control and status of the controller and peripheral functions, while GPRs are used for data storage and scratchpad operations in the user's application. Any read of an unimplemented location will read as '0's.

The instruction set and architecture allow operations across all banks. The entire data memory may be accessed by Direct, Indirect or Indexed Addressing modes. Addressing modes are discussed later in this section.

To ensure that commonly used registers (select SFRs and select GPRs) can be accessed in a single cycle, PIC18 devices implement an Access Bank. This is a 256-byte memory space that provides fast access to select SFRs and the lower portion of GPR Bank 0 without using the BSR. **Section 6.3.2 "Access Bank"** provides a detailed description of the Access RAM.

6.3.1 BANK SELECT REGISTER

Large areas of data memory require an efficient addressing scheme to make rapid access to any address possible. Ideally, this means that an entire address does not need to be provided for each read or write operation. For PIC18 devices, this is accomplished with a RAM banking scheme. This divides the memory space into 16 contiguous banks of 256 bytes. Depending on the instruction, each location can be addressed directly by its full 12-bit address, or an 8-bit low-order address and a 4-bit Bank Pointer.

Most instructions in the PIC18 instruction set make use of the Bank Pointer, known as the Bank Select Register (BSR). This SFR holds the 4 MSbs of a location's address; the instruction itself includes the 8 LSbs. Only the four lower bits of the BSR are implemented (BSR<3:0>). The upper four bits are unused; they will always read '0' and cannot be written to. The BSR can be loaded directly by using the `MOVLB` instruction.

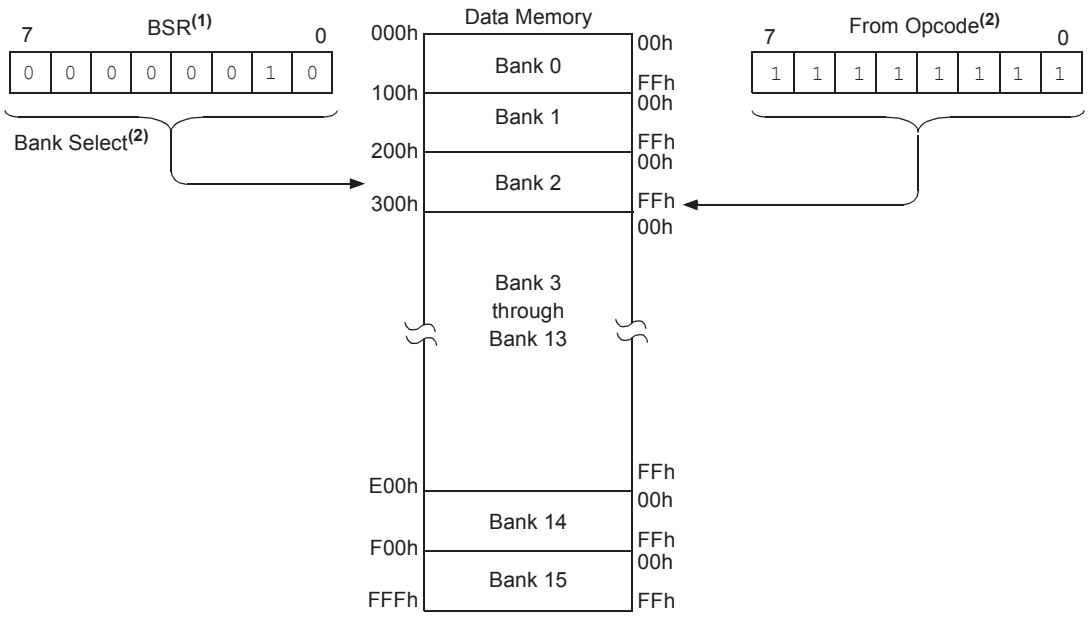
The value of the BSR indicates the bank in data memory. The 8 bits in the instruction show the location in the bank and can be thought of as an offset from the bank's lower boundary. The relationship between the BSR's value and the bank division in data memory is illustrated in Figure 6-7.

Because up to 16 registers can share the same low-order address, the user must always be careful to ensure that the proper bank is selected before performing a data read or write. For example, writing what should be program data to an 8-bit address of F9h, while the BSR is 0Fh, will end up resetting the PC.

While any bank can be selected, only those banks that are actually implemented can be read or written to. Writes to unimplemented banks are ignored, while reads from unimplemented banks will return '0's. Even so, the STATUS register will still be affected as if the operation was successful. The data memory map in Figure 6-6 indicates which banks are implemented.

In the core PIC18 instruction set, only the `MOVFF` instruction fully specifies the 12-bit address of the source and target registers. This instruction ignores the BSR completely when it executes. All other instructions include only the low-order address as an operand and must use either the BSR or the Access Bank to locate their target registers.

FIGURE 6-7: USE OF THE BANK SELECT REGISTER (DIRECT ADDRESSING)



Note 1: The Access RAM bit of the instruction can be used to force an override of the selected bank (BSR<3:0>) to the registers of the Access Bank.

2: The MOVFF instruction embeds the entire 12-bit address in the instruction.

6.3.2 ACCESS BANK

While the use of the BSR with an embedded 8-bit address allows users to address the entire range of data memory, it also means that the user must always ensure that the correct bank is selected. Otherwise, data may be read from, or written to, the wrong location. This can be disastrous if a GPR is the intended target of an operation, but an SFR is written to instead. Verifying and/or changing the BSR for each read or write to data memory can become very inefficient.

To streamline access for the most commonly used data memory locations, the data memory is configured with an Access Bank, which allows users to access a mapped block of memory without specifying a BSR. The Access Bank consists of the first 96 bytes of memory (00h-5Fh) in Bank 0 and the last 160 bytes of memory (60h-FFh) in Bank 15. The lower half is known as the Access RAM and is composed of GPRs. The upper half is where the device's SFRs are mapped. These two areas are mapped contiguously in the Access Bank and can be addressed in a linear fashion by an 8-bit address (Figure 6-6).

The Access Bank is used by core PIC18 instructions that include the Access RAM bit (the 'a' parameter in the instruction). When 'a' is equal to '1', the instruction uses the BSR and the 8-bit address included in the opcode for the data memory address. When 'a' is '0', however, the instruction is forced to use the Access Bank address map; the current value of the BSR is ignored entirely.

Using this "forced" addressing allows the instruction to operate on a data address in a single cycle without updating the BSR first. For 8-bit addresses of 60h and above, this means that users can evaluate and operate on SFRs more efficiently. The Access RAM below 60h is a good place for data values that the user might need to access rapidly, such as immediate computational results or common program variables. Access RAM also allows for faster and more code efficient context saving and switching of variables.

The mapping of the Access Bank is slightly different when the extended instruction set is enabled (XINST Configuration bit = 1). This is discussed in more detail in **Section 6.6.3 "Mapping the Access Bank in Indexed Literal Offset Mode"**.

6.3.3 GENERAL PURPOSE REGISTER FILE

PIC18 devices may have banked memory in the GPR area. This is data RAM, which is available for use by all instructions. GPRs start at the bottom of Bank 0 (address 000h) and grow upward toward the bottom of the SFR area. GPRs are not initialized by a POR and are unchanged on all other Resets.

REGISTER 9-5: PIR2: PERIPHERAL INTERRUPT REQUEST (FLAG) REGISTER 2 (ACCESS FA1h)

R/W-0	R/W-0	R/W-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
OSCFIF	CM2IF	CM1IF	—	BCL1IF	HLVDIF	TMR3IF	CCP2IF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **OSCFIF:** Oscillator Fail Interrupt Flag bit
1 = The device oscillator failed, clock input has changed to INTOSC (must be cleared in software)
0 = The device clock operating

bit 6 **CM2IF:** Comparator 2 Interrupt Flag bit
1 = The comparator input has changed (must be cleared in software)
0 = The comparator input has not changed

bit 5 **CM1IF:** Comparator 1 Interrupt Flag bit
1 = The comparator input has changed (must be cleared in software)
0 = The comparator input has not changed

bit 4 **Unimplemented:** Read as '0'

bit 3 **BCL1IF:** Bus Collision Interrupt Flag bit (MSSP1 module)
1 = A bus collision occurred (must be cleared in software)
0 = No bus collision occurred

bit 2 **HLVDIF:** High/Low-Voltage Detect (HLVD) Interrupt Flag bit
1 = A High/Low-Voltage condition occurred (must be cleared in software)
0 = An HLVD event has not occurred

bit 1 **TMR3IF:** TMR3 Overflow Interrupt Flag bit
1 = The TMR3 register overflowed (must be cleared in software)
0 = The TMR3 register did not overflow

bit 0 **CCP2IF:** ECCP2 Interrupt Flag bit
Capture mode:
1 = A TMR1/TMR3 register capture occurred (must be cleared in software)
0 = No TMR1/TMR3 register capture occurred
Compare mode:
1 = A TMR1/TMR3 register compare match occurred (must be cleared in software)
0 = No TMR1/TMR3 register compare match occurred
PWM mode:
Unused in this mode.

TABLE 10-5: PORTB I/O SUMMARY

Pin	Function	TRIS Setting	I/O	I/O Type	Description
RB0/AN12/ C3IND/INT0/ RP3	RB0	1	I	TTL	PORTB<0> data input; weak pull-up when the $\overline{\text{RBPU}}$ bit is cleared. Disabled when analog input is enabled.(1)
		0	O	DIG	LATB<0> data output; not affected by an analog input.
	AN12	1	I	ANA	A/D Input Channel 12.(1)
	C3IND	1	I	ANA	Comparator 3 Input D.
	INT0	1	I	ST	External Interrupt 0 input.
	RP3	1	I	ST	Remappable Peripheral Pin 3 input.
		0	O	DIG	Remappable Peripheral Pin 3 output.
RB1/AN10/ C3INC/PMBE/ RTCC/RP4	RB1	1	I	TTL	PORTB<1> data input; weak pull-up when the $\overline{\text{RBPU}}$ bit is cleared. Disabled when an analog input is enabled.(1)
		0	O	DIG	LATB<1> data output; not affected by an analog input.
	AN10	1	I	ANA	A/D Input Channel 10.(1)
	C3INC	1	I	ANA	Comparator 3 Input C.
	PMBE(3)	x	O	DIG	Parallel Master Port byte enable.
	RTCC	0	O	DIG	Asynchronous serial transmit data output (USART module).
	RP4	1	I	ST	Remappable Peripheral Pin 4 input.
		0	O	DIG	Remappable Peripheral Pin 4 output.
RB2/AN8/ C2INC/CTED1/ PMA3/REFO/ RP5	RB2	1	I	TTL	PORTB<2> data input; weak pull-up when the $\overline{\text{RBPU}}$ bit is cleared. Disabled when an analog input is enabled.(1)
		0	O	DIG	LATB<2> data output; not affected by an analog input.
	AN8	1	I	ANA	A/D Input Channel 8.(1)
	C2INC	1	I	ANA	Comparator 2 Input C.
	CTED1	1	I	ST	CTMU Edge 1 input.
	PMA3(3)	x	O	DIG	Parallel Master Port address.
	REFO	0	O	DIG	Reference output clock.
	RP5	1	I	ST	Remappable Peripheral Pin 5 input.
		0	O	DIG	Remappable Peripheral Pin 5 output.
RB3/AN9/ C3INA/CTED2/ PMA2/RP6	RB3	0	O	DIG	LATB<3> data output; not affected by analog input.
		1	I	TTL	PORTB<3> data input; weak pull-up when the $\overline{\text{RBPU}}$ bit is cleared. Disabled when analog input is enabled.(1)
	AN9	1	I	ANA	A/D Input Channel 9.(1)
	C3INA	1	I	ANA	Comparator 3 Input A.
	CTED2	1	I	ST	CTMU Edge 2 input.
	PMA2(3)	x	O	DIG	Parallel Master Port address.
	RP6	1	I	ST	Remappable Peripheral Pin 6 input.
		0	O	DIG	Remappable Peripheral Pin 6 output.

Legend: DIG = Digital level output; TTL = TTL input buffer; ST = Schmitt Trigger input buffer; ANA = Analog level input/output; x = Don't care (TRISx bit does not affect port direction or is overridden for this option)

Note 1: Pins are configured as analog inputs by default on POR. Using these pins for digital inputs requires setting the appropriate bits in the ANCON1 register.

2: All other pin functions are disabled when ICSP™ or ICD is enabled.

3: Only on 44-pin devices (PIC18F46J13, PIC18F47J13, PIC18LF46J13 and PIC18LF47J13).

4: Only on 28-pin devices (PIC18F26J13, PIC18F27J13, PIC18LF26J13 and PIC18LF27J13).

REGISTER 10-33: RPOR9: PERIPHERAL PIN SELECT OUTPUT REGISTER 9 (BANKED EC9h)

U-0	U-0	U-0	R/$\overline{W}$-0	R/$\overline{W}$-0	R/$\overline{W}$-0	R/$\overline{W}$-0	R/$\overline{W}$-0
—	—	—	RP9R4	RP9R3	RP9R2	RP9R1	RP9R0
bit 7							bit 0

Legend:	R/$\overline{W}$ = Readable bit, Writable bit if IOLOCK = 0		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **RP9R<4:0>:** Peripheral Output Function is Assigned to RP9 Output Pin bits
(see Table 10-14 for peripheral function numbers)

REGISTER 10-34: RPOR10: PERIPHERAL PIN SELECT OUTPUT REGISTER 10 (BANKED ECAh)

U-0	U-0	U-0	R/$\overline{W}$-0	R/$\overline{W}$-0	R/$\overline{W}$-0	R/$\overline{W}$-0	R/$\overline{W}$-0
—	—	—	RP10R4	RP10R3	RP10R2	RP10R1	RP10R0
bit 7							bit 0

Legend:	R/$\overline{W}$ = Readable bit, Writable bit if IOLOCK = 0		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **RP10R<4:0>:** Peripheral Output Function is Assigned to RP10 Output Pin bits
(see Table 10-14 for peripheral function numbers)

REGISTER 10-35: RPOR11: PERIPHERAL PIN SELECT OUTPUT REGISTER 11 (BANKED ECBh)

U-0	U-0	U-0	R/$\overline{W}$-0	R/$\overline{W}$-0	R/$\overline{W}$-0	R/$\overline{W}$-0	R/$\overline{W}$-0
—	—	—	RP11R4	RP11R3	RP11R2	RP11R1	RP11R0
bit 7							bit 0

Legend:	R/$\overline{W}$ = Readable bit, Writable bit if IOLOCK = 0		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-5 **Unimplemented:** Read as '0'

bit 4-0 **RP11R<4:0>:** Peripheral Output Function is Assigned to RP11 Output Pin bits
(see Table 10-14 for peripheral function numbers)

13.5.1 USING TIMER1 AS A CLOCK SOURCE

The Timer1 oscillator is also available as a clock source in power-managed modes. By setting the clock select bits, SCS<1:0> (OSCCON<1:0>), to '01', the device switches to SEC_RUN mode. Both the CPU and peripherals are clocked from the Timer1 oscillator. If the IDLEN bit (OSCCON<7>) is cleared and a SLEEP instruction is executed, the device enters SEC_IDLE mode. Additional details are available in **Section 4.0 "Low-Power Modes"**.

Whenever the Timer1 oscillator is providing the clock source, the Timer1 system clock status flag, SOSCRUN (OSCCON2<6>), is set. This can be used to determine the controller's current clocking mode. It can also indicate the clock source currently being used by the Fail-Safe Clock Monitor. If the Clock Monitor is enabled and the Timer1 oscillator fails while providing the clock, polling the SOSCRUN bit will indicate whether the clock is being provided by the Timer1 oscillator or another source.

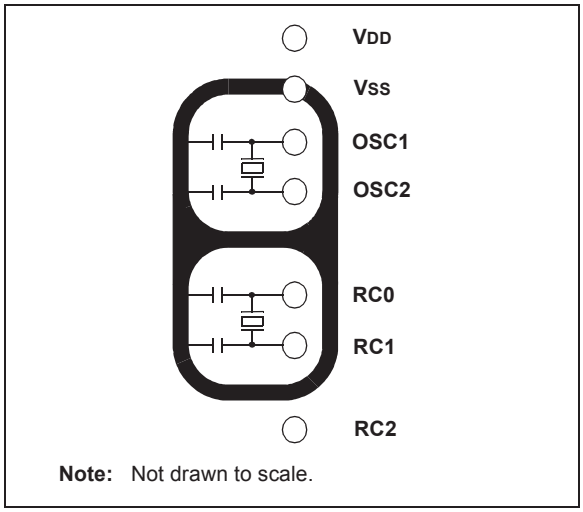
13.5.2 TIMER1 OSCILLATOR LAYOUT CONSIDERATIONS

The Timer1 oscillator circuit draws very little power during operation. Due to the low-power nature of the oscillator, it may also be sensitive to rapidly changing signals in close proximity. This is especially true when the oscillator is configured for extremely Low-Power mode (SOSCSEL = 0b01).

The oscillator circuit, displayed in Figure 13-2, should be located as close as possible to the microcontroller. There should be no circuits passing within the oscillator circuit boundaries other than VSS or VDD.

If a high-speed circuit must be located near the oscillator (such as the ECCP1 pin in Output Compare or PWM mode, or the primary oscillator using the OSC2 pin), a grounded guard ring around the oscillator circuit, as displayed in Figure 13-3, may be helpful when used on a single-sided PCB or in addition to a ground plane.

FIGURE 13-3: OSCILLATOR CIRCUIT WITH GROUNDED GUARD RING



Note: Not drawn to scale.

In the Low Drive Level mode, SOSCSEL = 0b01, it is critical that the RC2 I/O pin signals be kept away from the oscillator circuit. Configuring RC2 as a digital output, and toggling it, can potentially disturb the oscillator circuit, even with relatively good PCB layout. If possible, it is recommended to either leave RC2 unused, or use it as an input pin with a slew rate limited signal source. If RC2 must be used as a digital output, it may be necessary to use the Higher Drive Level Oscillator mode (SOSCSEL = 0b11) with many PCB layouts. Even in the High Drive Level mode, careful layout procedures should still be followed when designing the oscillator circuit.

In addition to dV/dt induced noise considerations, it is also important to ensure that the circuit board is clean. Even a very small amount of conductive soldering flux residue can cause PCB leakage currents which can overwhelm the oscillator circuit.

13.6 Timer1 Interrupt

The TMR1 register pair (TMR1H:TMR1L) increments from 0000h to FFFFh and rolls over to 0000h. The Timer1 interrupt, if enabled, is generated on overflow which is latched in interrupt flag bit, TMR1IF (PIR1<0>). This interrupt can be enabled or disabled by setting or clearing the Timer1 Interrupt Enable bit, TMR1IE (PIE1<0>).

REGISTER 17-5: ALRMRPT: ALARM REPEAT COUNTER (ACCESS F46h)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ARPT7	ARPT6	ARPT5	ARPT4	ARPT3	ARPT2	ARPT1	ARPT0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7-0 **ARPT<7:0>:** Alarm Repeat Counter Value bits

11111111 = Alarm will repeat 255 more times

.

.

.

00000000 = Alarm will not repeat

The counter decrements on any alarm event. The counter is prevented from rolling over from 00h to FFh unless CHIME = 1.

17.1.4 RTCEN BIT WRITE

An attempt to write to the RTCEN bit while RTCWREN = 0 will be ignored. RTCWREN must be set before a write to RTCEN can take place.

Like the RTCEN bit, the RTCVALH and RTCVALL registers can only be written to when RTCWREN = 1. A write to these registers, while RTCWREN = 0, will be ignored.

17.2 Operation

17.2.1 REGISTER INTERFACE

The register interface for the RTCC and alarm values is implemented using the Binary Coded Decimal (BCD) format. This simplifies the firmware when using the module, as each of the digits is contained within its own 4-bit value (see Figure 17-2 and Figure 17-3).

FIGURE 17-2: TIMER DIGIT FORMAT

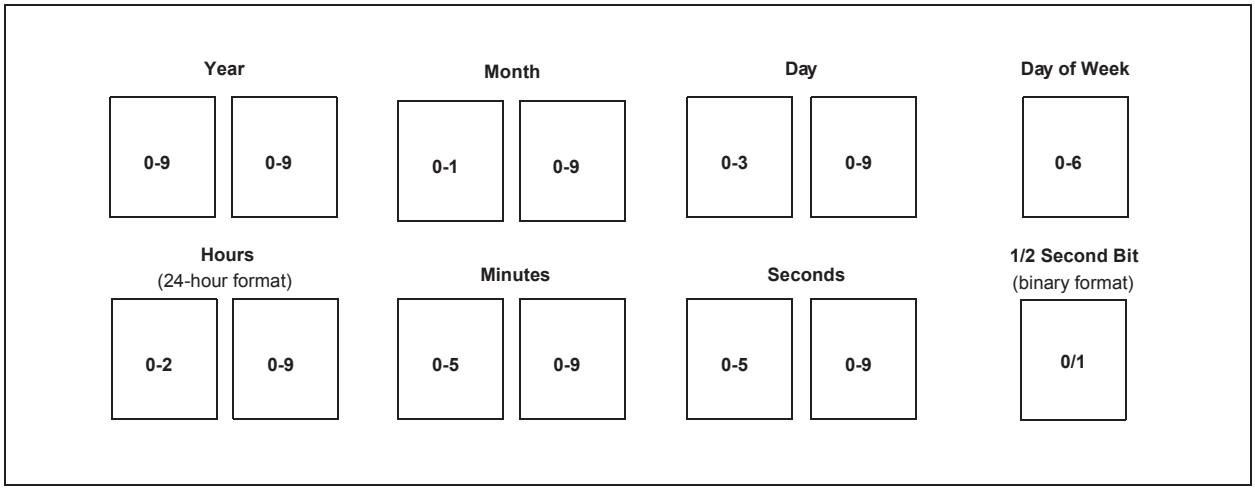
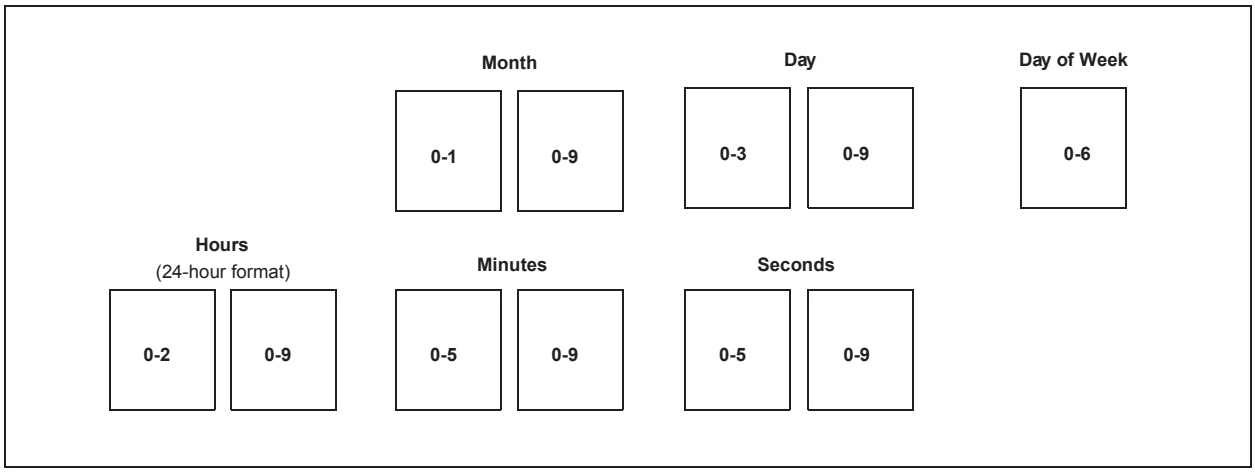


FIGURE 17-3: ALARM DIGIT FORMAT



19.4 PWM (Enhanced Mode)

The Enhanced PWM mode can generate a PWM signal on up to four different output pins with up to 10 bits of resolution. It can do this through four different PWM Output modes:

- Single PWM mode
- Half-Bridge PWM mode
- Full-Bridge PWM, Forward mode
- Full-Bridge PWM, Reverse mode

To select an Enhanced PWM mode, the PxM bits of the CCPxCON register must be set appropriately.

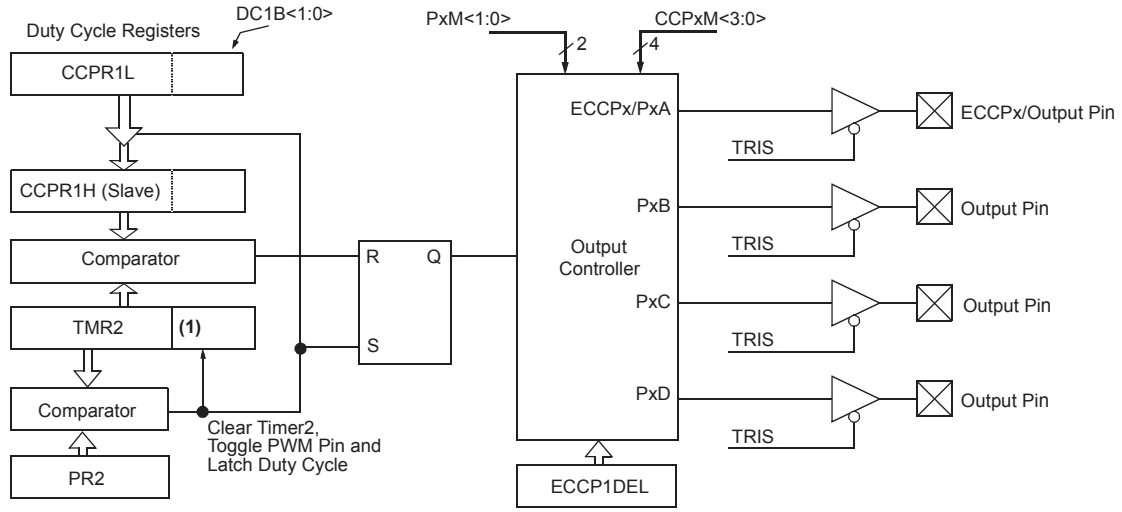
The PWM outputs are multiplexed with I/O pins and are designated: PxA, PxB, PxC and PxD. The polarity of the PWM pins is configurable and is selected by setting the CCPxM bits in the CCPxCON register appropriately.

Table 19-1 provides the pin assignments for each Enhanced PWM mode.

Figure 19-3 provides an example of a simplified block diagram of the Enhanced PWM module.

Note:	To prevent the generation of an incomplete waveform when the PWM is first enabled, the ECCP module waits until the start of a new PWM period before generating a PWM signal.

FIGURE 19-3: SIMPLIFIED BLOCK DIAGRAM OF THE ENHANCED PWM MODE EXAMPLE



Note 1: The 8-bit timer, TMR2 register, is concatenated with the 2-bit internal Q clock, or 2 bits of the prescaler, to create the 10-bit time base.

Note 1:	The TRIS register value for each PWM output must be configured appropriately.
2:	Any pin not used by an Enhanced PWM mode is available for alternate pin functions.

When a shutdown event occurs, two things happen:

- The ECCPxASE bit is set to '1'. The ECCPxASE will remain set until cleared in firmware or an auto-restart occurs. (See **Section 19.4.5 "Auto-Restart Mode"**.)
- The enabled PWM pins are asynchronously placed in their shutdown states. The PWM output pins are grouped into pairs (PxA/PxC and PxB/PxD). The state of each pin pair is determined by the PSSxAC and PSSxBD bits (ECCPxAS<3:0>).

Each pin pair may be placed into one of three states:

- Drive logic '1'
- Drive logic '0'
- Tri-state (high-impedance)

REGISTER 19-4: ECCPxAS: ECCP1/2/3 AUTO-SHUTDOWN CONTROL REGISTER (1, ACCESS FBEh; 2, FB8h; 3, BANKED F19h)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ECCPxASE	ECCPxAS2	ECCPxAS1	ECCPxAS0	PSSxAC1	PSSxAC0	PSSxBD1	PSSxBD0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **ECCPxASE:** ECCP Auto-Shutdown Event Status bit
1 = A shutdown event has occurred; ECCP outputs are in a shutdown state
0 = ECCP outputs are operating

bit 6-4 **ECCPxAS<2:0>:** ECCP Auto-Shutdown Source Select bits
000 = Auto-shutdown is disabled
001 = Comparator, C1OUT, output is high
010 = Comparator, C2OUT, output is high
011 = Either comparator, C1OUT or C2OUT, is high
100 = VIL on FLT0 pin
101 = VIL on FLT0 pin or comparator, C1OUT, output is high
110 = VIL on FLT0 pin or comparator, C2OUT, output is high
111 = VIL on FLT0 pin or comparator, C1OUT, or comparator, C2OUT, is high

bit 3-2 **PSSxAC<1:0>:** PxA and PxC Pins Shutdown State Control bits
00 = Drive pins, PxA and PxC, to '0'
01 = Drive pins, PxA and PxC, to '1'
1x = PxA and PxC pins tri-state

bit 1-0 **PSSxBD<1:0>:** PxB and PxD Pins Shutdown State Control bits
00 = Drive pins, PxB and PxD, to '0'
01 = Drive pins, PxB and PxD, to '1'
1x = PxB and PxD pins tri-state

Note 1: The auto-shutdown condition is a level-based signal, not an edge-based signal. As long as the level is present, the auto-shutdown will persist.
2: Writing to the ECCPxASE bit is disabled while an auto-shutdown condition persists.
3: Once the auto-shutdown condition has been removed and the PWM restarted (either through firmware or auto-restart), the PWM signal will always restart at the beginning of the next PWM period.

REGISTER 20-2: SSPxCON1: MSSPx CONTROL REGISTER 1 (SPI MODE) (1, ACCESS FC6h; 2, F72h)

R/W-0	R/C-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WCOL	SSPOV(1)	SSPEN(2)	CKP	SSPM3(3)	SSPM2(3)	SSPM1(3)	SSPM0(3)
bit 7							bit 0

Legend:	C = Clearable bit		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **WCOL:** Write Collision Detect bit
- 1 = The SSPxBUF register is written while it is still transmitting the previous word (must be cleared in software)
- 0 = No collision

bit 6 **SSPOV:** Receive Overflow Indicator bit(1)

SPI Slave mode:
- 1 = A new byte is received while the SSPxBUF register is still holding the previous data. In case of overflow, the data in SSPxSR is lost. Overflow can only occur in Slave mode. The user must read the SSPxBUF, even if only transmitting data, to avoid setting overflow (must be cleared in software).
- 0 = No overflow

bit 5 **SSPEN:** Master Synchronous Serial Port Enable bit(2)
- 1 = Enables serial port and configures SCKx, SDOx, SDIx and $\overline{SSx}$ as serial port pins
- 0 = Disables serial port and configures these pins as I/O port pins

bit 4 **CKP:** Clock Polarity Select bit
- 1 = Idle state for clock is a high level
- 0 = Idle state for clock is a low level

bit 3-0 **SSPM<3:0>:** Master Synchronous Serial Port Mode Select bits(3)
- 0101 = SPI Slave mode, clock = SCKx pin; $\overline{SSx}$ pin control disabled, $\overline{SSx}$ can be used as I/O pin
- 0100 = SPI Slave mode, clock = SCKx pin; $\overline{SSx}$ pin control enabled
- 0011 = SPI Master mode, clock = TMR2 output/2
- 0010 = SPI Master mode, clock = FOSC/64
- 0001 = SPI Master mode, clock = FOSC/16
- 1010 = SPI Master mode, clock = FOSC/8
- 0000 = SPI Master mode, clock = FOSC/4

Note 1: In Master mode, the overflow bit is not set since each new reception (and transmission) is initiated by writing to the SSPxBUF register.

2: When enabled, this pin must be properly configured as input or output.

3: Bit combinations not specifically listed here are either reserved or implemented in I^2C mode only.

REGISTER 20-5: SSPxSTAT: MSSPx STATUS REGISTER (I^2C MODE) (1, ACCESS FC7h; 2, F73h)

R/W-1	R/W-1	R-1	R-1	R-1	R-1	R-1	R-1
SMP	CKE	D/$\overline{A}$	P(1)	S(1)	R/$\overline{W}$(2,3)	UA	BF
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'	
-n = Value at POR	'1' = Bit is set	'0' = Bit is cleared	x = Bit is unknown

bit 7 **SMP:** Slew Rate Control bit

In Master or Slave mode:

1 = Slew rate control is disabled for Standard Speed mode (100 kHz and 1 MHz)

0 = Slew rate control is enabled for High-Speed mode (400 kHz)

bit 6 **CKE:** SMBus Select bit

In Master or Slave mode:

1 = Enable SMBus specific inputs

0 = Disable SMBus specific inputs

bit 5 **D/$\overline{A}$:** Data/$\overline{\text{Address}}$ bit

In Master mode:

Reserved.

In Slave mode:

1 = Indicates that the last byte received or transmitted was data

0 = Indicates that the last byte received or transmitted was address

bit 4 **P:** Stop bit(1)

1 = Indicates that a Stop bit has been detected last

0 = Stop bit was not detected last

bit 3 **S:** Start bit(1)

1 = Indicates that a Start bit has been detected last

0 = Start bit was not detected last

bit 2 **R/$\overline{W}$:** Read/$\overline{\text{Write}}$ Information bit(2,3)

In Slave mode:

1 = Read

0 = Write

In Master mode:

1 = Transmit is in progress

0 = Transmit is not in progress

bit 1 **UA:** Update Address bit (10-Bit Slave mode only)

1 = Indicates that the user needs to update the address in the SSPxADD register

0 = Address does not need to be updated

bit 0 **BF:** Buffer Full Status bit

In Transmit mode:

1 = SSPxBUF is full

0 = SSPxBUF is empty

In Receive mode:

1 = SSPxBUF is full (does not include the $\overline{\text{ACK}}$ and Stop bits)

0 = SSPxBUF is empty (does not include the $\overline{\text{ACK}}$ and Stop bits)

Note 1: This bit is cleared on Reset and when SSPEN is cleared.

2: This bit holds the R/$\overline{W}$ bit information following the last address match. This bit is only valid from the address match to the next Start bit, Stop bit or not $\overline{\text{ACK}}$ bit.

3: ORing this bit with SEN, RSEN, PEN, RCEN or ACKEN will indicate if the MSSPx is in Active mode.

29.11 Demonstration/Development Boards, Evaluation Kits, and Starter Kits

A wide variety of demonstration, development and evaluation boards for various PIC MCUs and dsPIC DSCs allows quick application development on fully functional systems. Most boards include prototyping areas for adding custom circuitry and provide application firmware and source code for examination and modification.

The boards support a variety of features, including LEDs, temperature sensors, switches, speakers, RS-232 interfaces, LCD displays, potentiometers and additional EEPROM memory.

The demonstration and development boards can be used in teaching environments, for prototyping custom circuits and for learning about various microcontroller applications.

In addition to the PICDEM™ and dsPICDEM™ demonstration/development board series of circuits, Microchip has a line of evaluation kits and demonstration software for analog filter design, KEELOQ® security ICs, CAN, IrDA®, PowerSmart battery management, SEEVAL® evaluation system, Sigma-Delta ADC, flow rate sensing, plus many more.

Also available are starter kits that contain everything needed to experience the specified device. This usually includes a single application and debug capability, all on one board.

Check the Microchip web page (www.microchip.com) for the complete list of demonstration, development and evaluation kits.

29.12 Third-Party Development Tools

Microchip also offers a great collection of tools from third-party vendors. These tools are carefully selected to offer good value and unique functionality.

- Device Programmers and Gang Programmers from companies, such as SoftLog and CCS
- Software Tools from companies, such as Gimpel and Trace Systems
- Protocol Analyzers from companies, such as Saleae and Total Phase
- Demonstration Boards from companies, such as MikroElektronika, Digilent® and Olimex
- Embedded Ethernet Solutions from companies, such as EZ Web Lynx, WIZnet and IPLogika®

30.2 DC Characteristics: Power-Down and Supply Current PIC18F47J13 Family (Industrial) (Continued)

PIC18LF47J13 Family		Standard Operating Conditions (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for industrial					
PIC18F47J13 Family		**Standard Operating Conditions (unless otherwise stated)** Operating temperature -40°C ≤ TA ≤ +85°C for industrial					
Param No.	**Device**	**Typ**	**Max**	**Units**	**Conditions**		
	PIC18LFXXJ13	9	45	µA	-40°C	VDD = 2.5V, VDDCORE = 2.5V	FOSC = 32 kHz(3), **SEC_RUN** mode, SOSCSEL = 0b01
		9	45	µA	+25°C		
		12	61	µA	+85°C		
	PIC18FXXJ13	24	95	µA	-40°C	VDD = 2.15V, VDDCORE = 10 µF	
		28	95	µA	+25°C		
		35	105	µA	+85°C		
	PIC18FXXJ13	27	110	µA	-40°C	VDD = 3.3V, VDDCORE = 10 µF	
		31	110	µA	+25°C		
		35	150	µA	+85°C		
	PIC18LFXXJ13	2.5	31	µA	-40°C	VDD = 2.5V, VDDCORE = 2.5V	FOSC = 32 kHz(3), **SEC_IDLE** mode, SOSCSEL = 0b01
		3.0	31	µA	+25°C		
		6.1	50	µA	+85°C		
	PIC18FXXJ13	19	87	µA	-40°C	VDD = 2.15V, VDDCORE = 10 µF	
		24	89	µA	+25°C		
		31	97	µA	+85°C		
	PIC18FXXJ13	21	100	µA	-40°C	VDD = 3.3V, VDDCORE = 10 µF	
		25	100	µA	+25°C		
		31	140	µA	+85°C		

Note 1: The power-down current in Sleep mode does not depend on the oscillator type. Power-down current is measured with the part in Sleep mode, with all I/O pins in a high-impedance state and tied to VDD or VSS, and all features that add delta current are disabled (such as WDT, Timer1 oscillator, BOR, etc.).

2: The supply current is mainly a function of operating voltage, frequency and mode. Other factors, such as I/O pin loading and switching rate, oscillator type and circuit, internal code execution pattern and temperature, also have an impact on the current consumption. All features that add delta current are disabled (such as WDT). The test conditions for all IDD measurements in active operation mode are:
OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD/VSS;
$\overline{MCLR}$ = VDD; WDT disabled unless otherwise specified.

3: Low-power Timer1 with standard, low-cost 32 kHz crystals have an operating temperature range of -10°C to +70°C. Extended temperature crystals are available at a much higher cost.

30.5.2 TIMING CONDITIONS

The temperature and voltages specified in Table 30-8 apply to all timing specifications unless otherwise noted. Figure 30-4 specifies the load conditions for the timing specifications.

TABLE 30-8: TEMPERATURE AND VOLTAGE SPECIFICATIONS – AC

AC CHARACTERISTICS	**Standard Operating Conditions (unless otherwise stated)** Operating temperature -40°C ≤ TA ≤ +85°C for industrial Operating voltage VDD range as described in **Section 30.1** and **Section 30.3**.

FIGURE 30-4: LOAD CONDITIONS FOR DEVICE TIMING SPECIFICATIONS

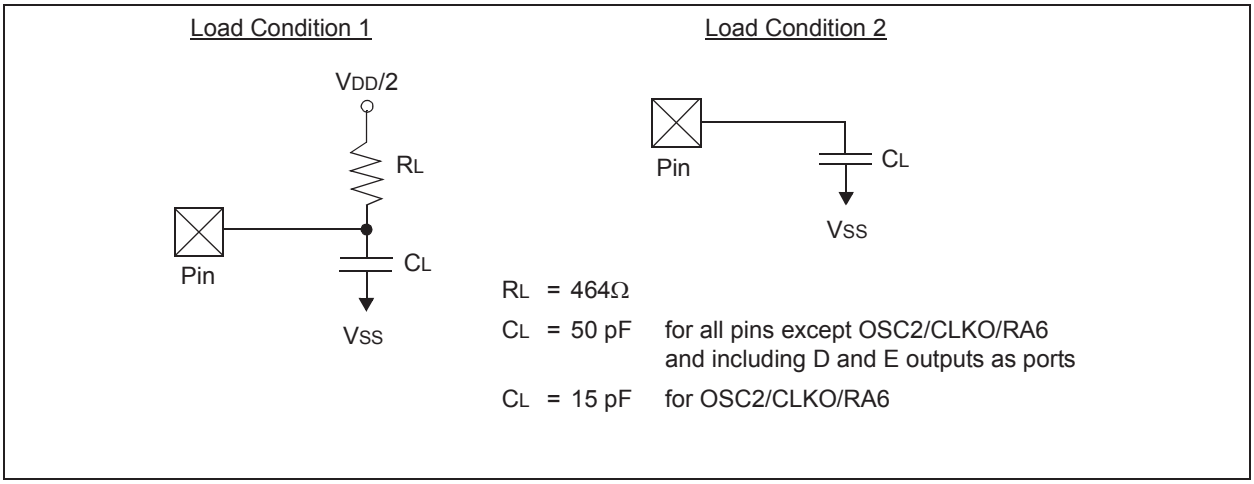


FIGURE 30-12: PARALLEL SLAVE PORT TIMING

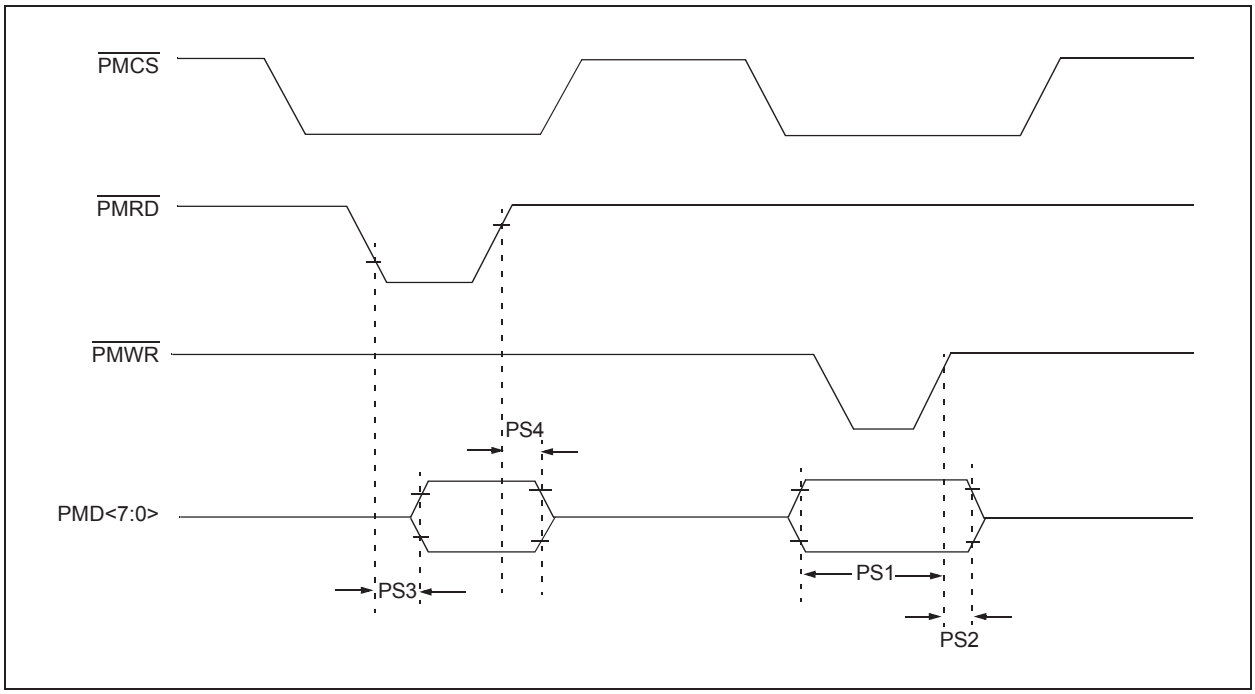


TABLE 30-20: PARALLEL SLAVE PORT REQUIREMENTS

AC CHARACTERISTICS			Standard Operating Conditions: 2.0V to 3.6V (unless otherwise stated) Operating temperature -40°C ≤ TA ≤ +85°C for Industrial				
Param. No.	**Symbol**	**Characteristic**	**Min**	**Typ**	**Max**	**Units**	**Conditions**
PS1	TdtV2wrH	Data In Valid before $\overline{\text{PMWR}}$ or $\overline{\text{PMCS}}$ Inactive (setup time)	20	—	—	ns	
PS2	TwrH2dtI	$\overline{\text{PMWR}}$ or $\overline{\text{PMCS}}$ Inactive to Data–In Invalid (hold time)	20	—	—	ns	
PS3	TrdL2dtV	$\overline{\text{PMRD}}$ and $\overline{\text{PMCS}}$ Active to Data–Out Valid	—	—	80	ns	
PS4	TrdH2dtI	$\overline{\text{PMRD}}$ Inactive or $\overline{\text{PMCS}}$ Inactive to Data–Out Invalid	10	—	30	ns	

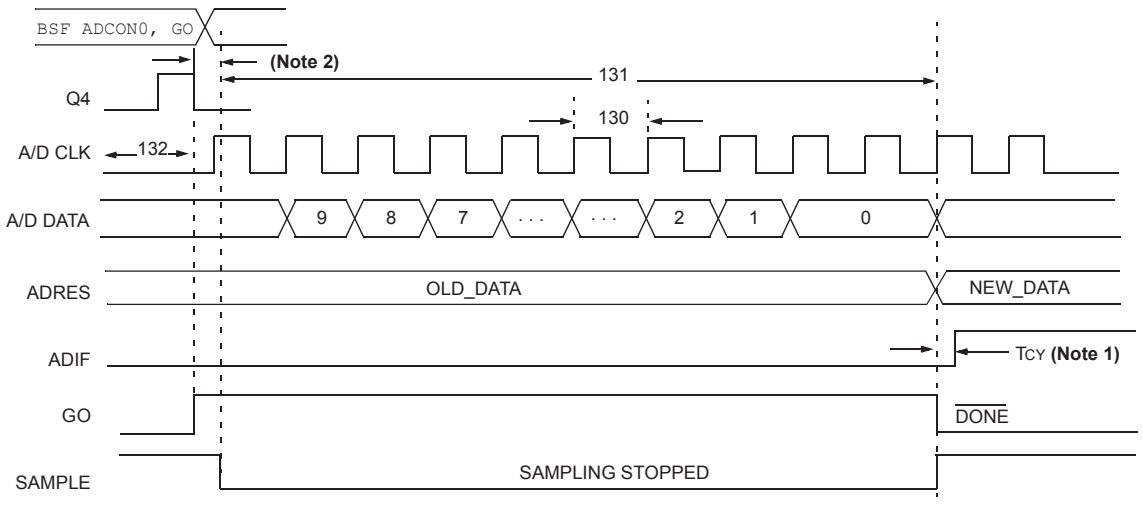
TABLE 30-31: A/D CONVERTER CHARACTERISTICS: PIC18F47J13 FAMILY (INDUSTRIAL)

Param No.	Symbol	Characteristic	Min	Typ	Max	Units	Conditions
A01	NR	Resolution	—	—	12	bit	ΔVREF ≥ 3.0V
A03	EIL	Integral Linearity Error	—	<±1	±2	LSb	ΔVREF ≥ 3.0V
A04	EDL	Differential Linearity Error	—	<±1	1.5	LSb	ΔVREF ≥ 3.0V
A06	EOFF	Offset Error	—	<±1	5	LSb	ΔVREF ≥ 3.0V
A07	EGN	Gain Error	—	—	<±3.5	LSb	ΔVREF ≥ 3.0V
A10		Monotonicity	Guaranteed(1)			—	VSS ≤ VAIN ≤ VREF
A20	ΔVREF	Reference Voltage Range (VREFH – VREFL)	2.0 3	— —	— —	V V	VDD < 3.0V VDD ≥ 3.0V
A21	VREFH	Reference Voltage High For 10-bit resolution For 12-bit resolution	 VREFL VSS + 3V	 — —	 VDD + 0.3V VDD + 0.3V	 V V	
A22	VREFL	Reference Voltage Low For 10-bit resolution For 12-bit resolution	 VSS – 0.3V VSS – 0.3V	 — —	 VREFH VDD - 3V	 V V	
A25	VAIN	Analog Input Voltage	VREFL	—	VREFH	V	
A30	ZAIN	Recommended Impedance of Analog Voltage Source For 10-bit resolution For 12-bit resolution	 — —	 — —	 2.5 1	 kΩ kΩ	
A50	IREF	VREF Input Current(2)	— —	— —	5 150	μA μA	During VAIN acquisition. During A/D conversion cycle.

Note 1: The A/D conversion result never decreases with an increase in the input voltage and has no missing codes.

2: VREFH current is from RA3/AN3/C1INBVREF+ pin or VDD, whichever is selected as the VREFH source. VREFL current is from RA2/AN2/C2INB/C1IND/C3INB/VREF-/CVREF pin or VSS, whichever is selected as the VREFL source.

FIGURE 30-23: A/D CONVERSION TIMING



Note 1: If the A/D clock source is selected as RC, a time of TCY is added before the A/D clock starts. This allows the SLEEP instruction to be executed.

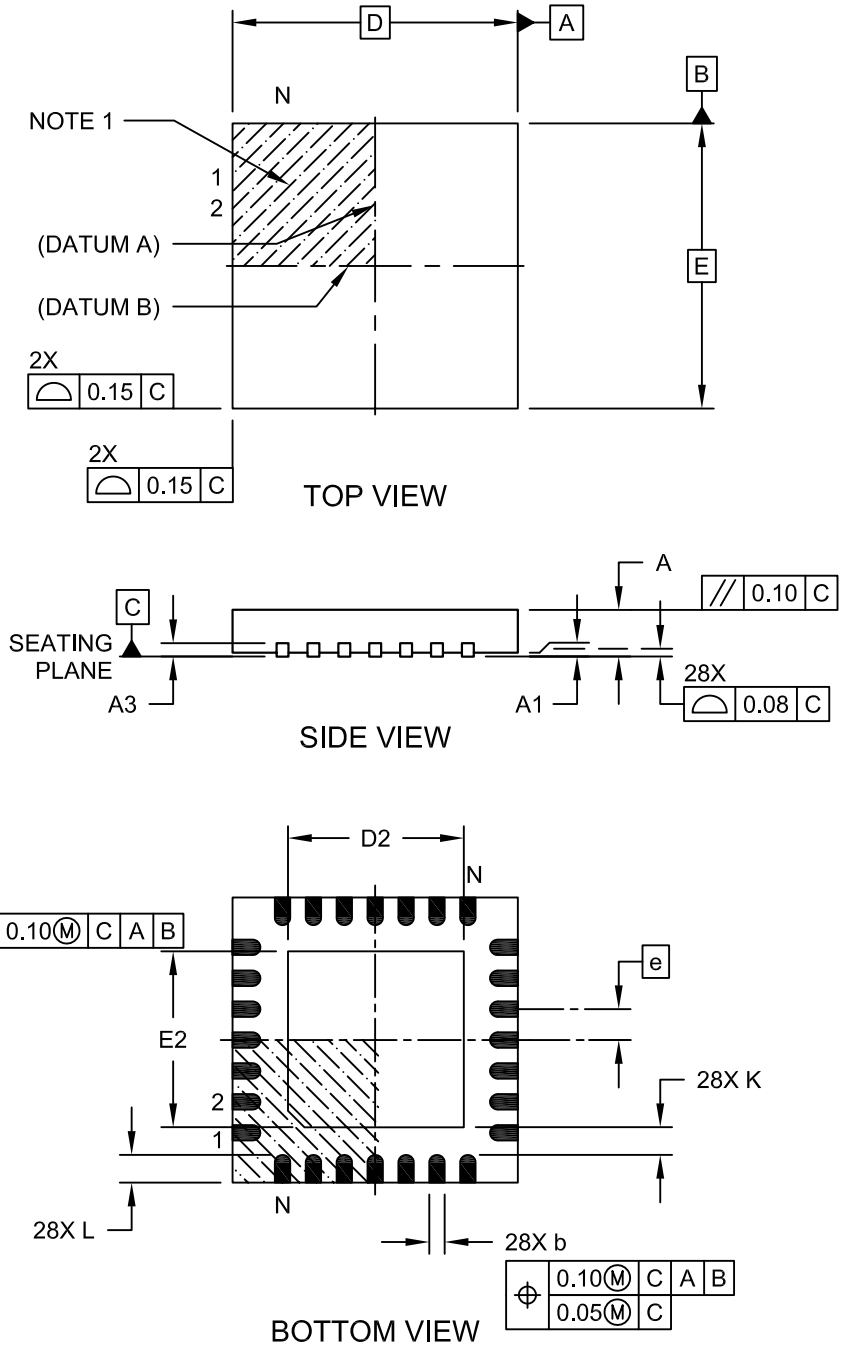
2: This is a minimal RC delay (typically 100 ns), which also disconnects the holding capacitor from the analog input.

31.2 Package Details

The following sections give the technical details of the packages.

28-Lead Plastic Quad Flat, No Lead Package (ML) - 6x6 mm Body [QFN] With 0.55 mm Terminal Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-105C Sheet 1 of 2